



PIC24FJ256GA705 FAMILY

PIC24FJ256GA705 Family Silicon Errata and Data Sheet Clarification

The PIC24FJ256GA705 family devices that you have received conform functionally to the current Device Data Sheet (DS30010118B), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.


The errata described in this document will be addressed in future revisions of the PIC24FJ256GA705 family silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (A3).

Data Sheet clarifications and corrections start on Page 6, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
 - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ().
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC24FJ256GA705 family silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾	Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾
		A3			A3
PIC24FJ64GA705	0x7507	0x03	PIC24FJ256GA704	0x750D	0x03
PIC24FJ128GA705	0x750B		PIC24FJ64GA702	0x7506	
PIC24FJ256GA705	0x750F		PIC24FJ128GA702	0x750A	
PIC24FJ64GA704	0x7505		PIC24FJ256GA702	0x750E	
PIC24FJ128GA704	0x7509				

- Note 1:** The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".
- 2:** Refer to the "PIC24FJ256GA705 Family Flash Programming Specification" (DS30010102) for detailed information on Device and Revision IDs for your specific device.

PIC24FJ256GA705 FAMILY

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revisions ⁽¹⁾
				A3
I ² C	Address Hold	1.	In Slave mode when AHEN = 1 (Address Hold Enable), if ACKDT (Acknowledge Data bit) is set at the beginning of address reception, clock stretching will not happen after the 8th clock.	X
Reset	Trap Conflict	2.	The TRAPR bit is not getting set when a hard trap conflict occurs.	X
I ² C	Data Hold	3.	In Slave mode when DHEN = 1 (Data Hold Enable), if ACKDT (Acknowledge Data bit) is set at the beginning of data reception, then a slave interrupt will not occur after the 8th clock.	X
Primary XT and HS Oscillator (POSC)	Primary Oscillator Start-up Timer (OST)	4.	OST may indicate oscillator is ready for use too early.	X
Power	Retention Sleep	5.	When the device wakes up from Retention Sleep mode (RETEN bit (RCON<12>) = 1, $\overline{\text{LPCFG}}$ bit (FPOR<2>) = 0), a device Reset may occur. The BOR, POR and EXTR bits in the RCON register are set erroneously for this Reset.	X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

PIC24FJ256GA705 FAMILY

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A3**).

1. Module: I²C

In Slave mode when AHEN = 1 (Address Hold Enable), if the ACKDT bit (Acknowledge Data) is set at the beginning of address reception, clock stretching will not happen after the 8th clock.

Work around

In Slave mode, user software should clear ACKDT on receiving the Start bit.

Affected Silicon Revisions

A3							
X							

2. Module: Reset

If a lower priority address error trap occurs while a higher priority oscillator failure trap is being processed, the TRAPR bit (RCON<15>) is not set. A Trap Conflict Reset does not occur as expected and the device may stop executing code.

Work around

None. However, a $\overline{\text{MCLR}}$ /POR Reset will recover the device.

Affected Silicon Revisions

A3							
X							

3. Module: I²C

In Slave mode when DHEN = 1 (Data Hold Enable), if the ACKDT bit (Acknowledge Data) is set at the beginning of data reception, then the slave interrupt will not occur after the 8th clock.

Work around

In Slave mode, user software should clear ACKDT on receiving the Start bit.

Affected Silicon Revisions

A3							
X							

PIC24FJ256GA705 FAMILY

4. Module: Primary XT and HS Oscillator (POSC)

The Primary Oscillator Start-up Timer (OST) may indicate the oscillator is ready for use too early. Clocking the device before the oscillator is ready may result in incorrect execution and exceptions. This issue exists when the POSC is requested at power-on, during clock switching, when waking from Sleep or when a peripheral module requests the POSC directly. This issue affects XT and HS modes only.

Work around

Make sure that the Primary Oscillator clock is ready before using it by following these steps:

1. Running on a non-POSC source, request the POSC clock using a peripheral such as REFO.
2. Provide a delay to stabilize the POSC.
3. Switch to the POSC source.

[Example 1](#) shows a work around for the device power-on and [Example 2](#) explains the work around when the device wakes from Sleep.

EXAMPLE 1: USING POSC AT POWER-ON

```
#pragma config FNOOSC = FRC           // Oscillator Selection bits (Fast RC oscillator (FRC))
// Clock Switching Enabled (Fail-safe Clock Monitor can be enabled or disabled)
#pragma config FCKSM = CSECMD
-----
int main()
{
    // configure REFO to request POSC
    REFOCONLbits.ROSEL = 2;           // POSC
    REFOCONLbits.ROOUT = 0;           // disable output
    REFOCONLbits.ROEN = 1;           // enable module

    // wait for POSC stable clock
    // this delay may vary depending on different application conditions
    // such as voltage, temperature, layout, XT or HS mode and components
    { // delay for 9 ms
        unsigned int delaysms = 9;
        while(delaysms--) asm volatile("repeat #(8000000/1000/2) \n nop");
    }

    // switch to POSC = 2
    __builtin_write_OSCCONH(2);
    __builtin_write_OSCCONL(1);
    while(OSCCONbits.OSWEN == 1);    // wait for switch
```

PIC24FJ256GA705 FAMILY

EXAMPLE 2: USING POSC WHEN WAKING FROM SLEEP

```
// Clock Switching Enabled (Failsafe Clock Monitor can be enabled or disabled)
#pragma config FCKSM = CSECMD
-----
// switch to FRC = 0 before entering sleep
__builtin_write_OSCCONH(0);
__builtin_write_OSCCONL(1);
while(OSCCONbits.OSWEN == 1); // wait for switch

// enter sleep mode
Sleep();

// configure REFO to request POSC
REFOCONLbits.ROSEL = 2; // POSC
REFOCONLbits.ROOUT = 0; // disable output
REFOCONLbits.ROEN = 1; // enable module

// wait for POSC stable clock
// this delay may vary depending on different application conditions
// such as voltage, temperature, layout, XT or HS mode and components
{ // delay for 9 ms
    unsigned int delaysms = 9;
    while(delaysms--) asm volatile("repeat #(8000000/1000/2) \n nop");
}

// switch to POSC = 2
__builtin_write_OSCCONH(2);
__builtin_write_OSCCONL(1);
while(OSCCONbits.OSWEN == 1); // wait for switch
```

Affected Silicon Revisions

A3								
X								

5. Module: Power

When the device wakes up from Retention Sleep mode (RETEN bit (RCON<12>) = 1, LPCFG bit (FPOR<2>) = 0), occasionally a device reset may occur. The BOR, POR and EXTR bits in the RCON register are set erroneously for this Reset.

Work around

To provide a consistent behavior when the device wakes up from Retention Sleep mode, a software RESET instruction (RESET) should be inserted following the SLEEP instruction. In this case, a Reset will be always be generated when the device wakes up from Retention Sleep. [Example 3](#) shows the software RESET instruction implementation:

EXAMPLE 3: SOFTWARE RESET AFTER SLEEP INSTRUCTION

```
// ENTER SLEEP MODE.
asm volatile ("pwrsav #0");
// SOFTWARE RESET RIGHT AFTER SLEEP.
asm volatile("reset");
```

Affected Silicon Revisions

A3								
X								

PIC24FJ256GA705 FAMILY

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS30010118B):

Note: Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

None.

PIC24FJ256GA705 FAMILY

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (10/2016)

Initial release of this document; issued for Revision A3.

Rev B Document (12/2016)

Added silicon errata issue 5 (Power).

PIC24FJ256GA705 FAMILY

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable.”

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELoQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

**QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
= ISO/TS 16949 =**

Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BeaconThings, BitCloud, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KEELoQ, KEELoQ logo, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, RightTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, chipKIT, chipKIT logo, CodeGuard, CryptoAuthentication, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICKit, PICtail, PureSilicon, QMatrix, RightTouch logo, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2016, Microchip Technology Incorporated, All Rights Reserved.
ISBN: 978-1-5224-1216-8



MICROCHIP

Worldwide Sales and Service

AMERICAS

Corporate Office

2355 West Chandler Blvd.
Chandler, AZ 85224-6199

Tel: 480-792-7200

Fax: 480-792-7277

Technical Support:

[http://www.microchip.com/
support](http://www.microchip.com/support)

Web Address:

www.microchip.com

Atlanta

Duluth, GA

Tel: 678-957-9614

Fax: 678-957-1455

Austin, TX

Tel: 512-257-3370

Boston

Westborough, MA

Tel: 774-760-0087

Fax: 774-760-0088

Chicago

Itasca, IL

Tel: 630-285-0071

Fax: 630-285-0075

Dallas

Addison, TX

Tel: 972-818-7423

Fax: 972-818-2924

Detroit

Novi, MI

Tel: 248-848-4000

Houston, TX

Tel: 281-894-5983

Indianapolis

Noblesville, IN

Tel: 317-773-8323

Fax: 317-773-5453

Tel: 317-536-2380

Los Angeles

Mission Viejo, CA

Tel: 949-462-9523

Fax: 949-462-9608

Tel: 951-273-7800

Raleigh, NC

Tel: 919-844-7510

New York, NY

Tel: 631-435-6000

San Jose, CA

Tel: 408-735-9110

Tel: 408-436-4270

Canada - Toronto

Tel: 905-695-1980

Fax: 905-695-2078

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor
Tower 6, The Gateway
Harbour City, Kowloon

Hong Kong

Tel: 852-2943-5100

Fax: 852-2401-3431

Australia - Sydney

Tel: 61-2-9868-6733

Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8569-7000

Fax: 86-10-8528-2104

China - Chengdu

Tel: 86-28-8665-5511

Fax: 86-28-8665-7889

China - Chongqing

Tel: 86-23-8980-9588

Fax: 86-23-8980-9500

China - Dongguan

Tel: 86-769-8702-9880

China - Guangzhou

Tel: 86-20-8755-8029

China - Hangzhou

Tel: 86-571-8792-8115

Fax: 86-571-8792-8116

China - Hong Kong SAR

Tel: 852-2943-5100

Fax: 852-2401-3431

China - Nanjing

Tel: 86-25-8473-2460

Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355

Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-3326-8000

Fax: 86-21-3326-8021

China - Shenyang

Tel: 86-24-2334-2829

Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8864-2200

Fax: 86-755-8203-1760

China - Wuhan

Tel: 86-27-5980-5300

Fax: 86-27-5980-5118

China - Xian

Tel: 86-29-8833-7252

Fax: 86-29-8833-7256

ASIA/PACIFIC

China - Xiamen

Tel: 86-592-2388138

Fax: 86-592-2388130

China - Zhuhai

Tel: 86-756-3210040

Fax: 86-756-3210049

India - Bangalore

Tel: 91-80-3090-4444

Fax: 91-80-3090-4123

India - New Delhi

Tel: 91-11-4160-8631

Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-3019-1500

Japan - Osaka

Tel: 81-6-6152-7160

Fax: 81-6-6152-9310

Japan - Tokyo

Tel: 81-3-6880-3770

Fax: 81-3-6880-3771

Korea - Daegu

Tel: 82-53-744-4301

Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200

Fax: 82-2-558-5932 or

82-2-558-5934

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857

Fax: 60-3-6201-9859

Malaysia - Penang

Tel: 60-4-227-8870

Fax: 60-4-227-4068

Philippines - Manila

Tel: 63-2-634-9065

Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870

Fax: 65-6334-8850

Taiwan - Hsin Chu

Tel: 886-3-5778-366

Fax: 886-3-5770-955

Taiwan - Kaohsiung

Tel: 886-7-213-7830

Taiwan - Taipei

Tel: 886-2-2508-8600

Fax: 886-2-2508-0102

Thailand - Bangkok

Tel: 66-2-694-1351

Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Fax: 43-7242-2244-393

Denmark - Copenhagen

Tel: 45-4450-2828

Fax: 45-4485-2829

Finland - Espoo

Tel: 358-9-4520-820

France - Paris

Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

France - Saint Cloud

Tel: 33-1-30-60-70-00

Germany - Garching

Tel: 49-8931-9700

Germany - Haan

Tel: 49-2129-3766400

Germany - Heilbronn

Tel: 49-7131-67-3636

Germany - Karlsruhe

Tel: 49-721-625370

Germany - Munich

Tel: 49-89-627-144-0

Fax: 49-89-627-144-44

Germany - Rosenheim

Tel: 49-8031-354-560

Israel - Ra'anana

Tel: 972-9-744-7705

Italy - Milan

Tel: 39-0331-742611

Fax: 39-0331-466781

Italy - Padova

Tel: 39-049-7625286

Netherlands - Drunen

Tel: 31-416-690399

Fax: 31-416-690340

Norway - Trondheim

Tel: 47-7289-7561

Poland - Warsaw

Tel: 48-22-3325737

Romania - Bucharest

Tel: 40-21-407-87-50

Spain - Madrid

Tel: 34-91-708-08-90

Fax: 34-91-708-08-91

Sweden - Gothenberg

Tel: 46-31-704-60-40

Sweden - Stockholm

Tel: 46-8-5090-4654

UK - Wokingham

Tel: 44-118-921-5800

Fax: 44-118-921-5820